

Title (en)

ELECTRONICS UNIT AND METHOD FOR THE PRODUCTION THEREOF

Title (de)

ELEKTRONIKEINHEIT UND VERFAHREN ZU DEREN HERSTELLUNG

Title (fr)

UNITÉ ÉLECTRONIQUE ET SON PROCÉDÉ DE FABRICATION

Publication

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Application

EP 21783464 A 20210924

Priority

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- EP 2021076343 W 20210924

Abstract (en)

[origin: CA3193519A1] The invention relates to a production method for an electronics unit (1) and to an electronics unit which comprises a first component (2) with a plurality of first electrical contacts (3), said first component having an integrated circuit (6), and a second component (4) with a plurality of second electrical contacts (5). The first electrical contacts (3) and the second electrical contacts (5) are each electrically connected to one another via an electrically conductive structure (8) which comprises a plurality of electrically conductive particles (9).

IPC 8 full level

H01L 21/56 (2006.01)

CPC (source: EP US)

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Citation (search report)

See references of WO 2022063977A2

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